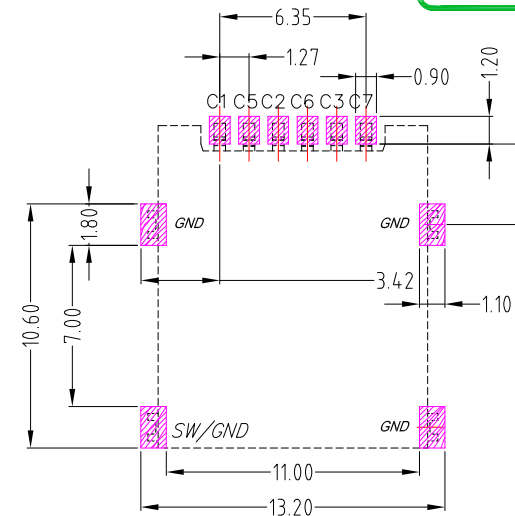
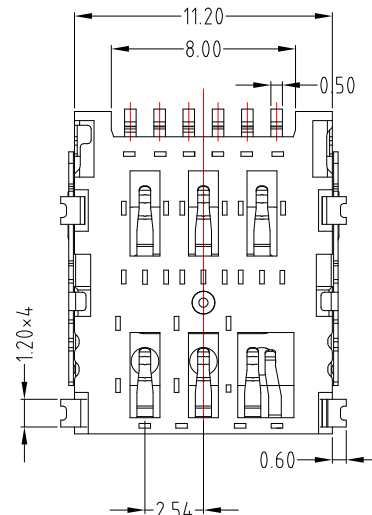
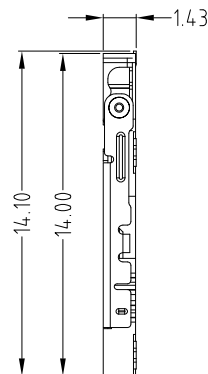
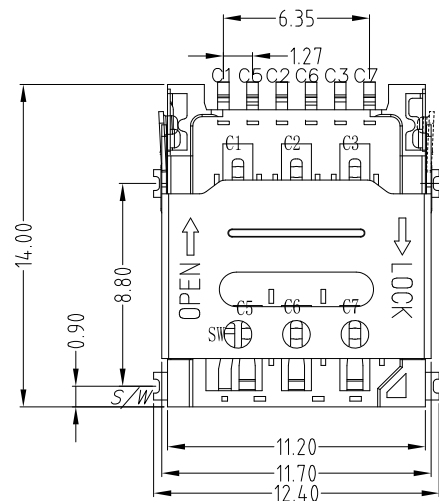
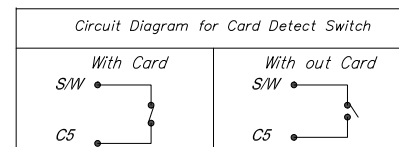
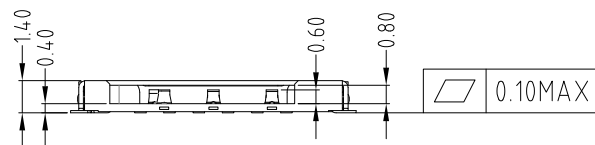
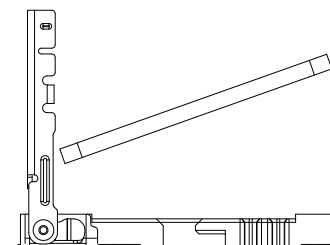




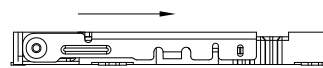
P.C.B LAYOUT MOUNTING PATTERN



PIN NO.	PIN NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O
S/W	SWTSH PIN



STEP 1 INSERT NANO SIM CARD



STEP 2 PUSH THE SHELL



STEP 3 FINISH

SPECIFICATION:

1. CURRENT RATING : 0.5 mA AC / DC MAX.
2. VOLTAGE RATING : 5V AC / DC
3. INSULATION RESISTANCE : 100MΩ MIN.
4. CONTACT RESISTANCE : 80mΩ MAX.
5. OPERATING TEMPERATURE : -40°C TO +85°C.
6. STORAGE TEMPERATURE : -40°C TO +85°C.
7. LIFE : 5000 CYCLES

MATERIALS:

1. HOUSING : LCP
2. CONTACT : PHOSPHOR BRONZE
3. SHELL : SUS

Finish:

1. Finish: CONTACT: PLATED GOLD IN MATING AREA ;
GOLD PLATED ON SOLDER BALLS ;
NICKEL UNDER PLATED OVERALL
2. SHELL: NICKEL UNDER PLATED SURFACE LAYER

6	更新樣式	Jack	032024
5	更新樣式	Jack	022924
4	新增半鑿度標示	Jack	072723
3	新增pin編號	Jack	091322
2	更新料號	Jack	070522
1	更新OPERATING TEMPERATURE	Jack	080621
ITEM NO.	DESCRIPTION	DRAWN	DATE

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED:
Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3

3RD.
ANGEL'S



UNITS

MM

DRAWN BY:	DATE
Jack Lu	03/20/24
CHECKED BY:	DATE
Jacky Chen	03/20/24
APPROVED BY:	DATE
Tony Kao	03/20/24

MAT'L	TITLE	CONNECTOR
FINISH	MODLE	Nano SIM CARD 掀蓋 1.40H 7P 帶開關
SCALE	DWG NO.	NSIM-SFB007R-S267
SHEET NO.	PART NO.	NSIM-SFB007R-S267
1 of 1		